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December 2014

# FDPF041N06BL1

# N-Channel PowerTrench<sup>®</sup> MOSFET 60 V, 77 A, 4.1 m $\Omega$

### **Features**

- $R_{DS(on)} = 3.5 \text{ m}\Omega$  ( Typ.) @  $V_{GS} = 10 \text{ V}$ ,  $I_D = 77 \text{ A}$
- Low FOM R<sub>DS(on)</sub>\*Q<sub>G</sub>
- Low Reverse Recovery Charge, Q<sub>rr</sub>
- Soft Reverse Recovery Body Diode
- Enables Highly Efficiency in Synchronous Rectification
- · Fast Switching Speed
- 100% UIL Tested
- · RoHS Compliant

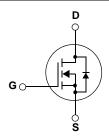
# **Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor<sup>®</sup>'s advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

# **Applications**

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Renewable System





# MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		Parameter		FDPF041N06BL1	Unit
V <sub>DSS</sub>	Drain to Source Voltage			60	V
V <sub>GSS</sub>	Gate to Source Voltage			±20	V
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25°C, Silicon Li	mited)	77	А
	Drain Current	- Continuous (T <sub>C</sub> = 100°C, Silicon I	_imited)	55	_ A
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	308	Α
E <sub>AS</sub>	Single Pulsed Avalanche Er	ergy	(Note 2)	365	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6.0	V/ns
D	Danier Diagination	$(T_C = 25^{\circ}C)$		44.1	W
$P_{D}$	Power Dissipation	- Derate above 25°C		0.29	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Tem	perature Range		-55 to +175	οС
T <sub>L</sub>	Maximum Lead Temperature 1/8" from Case for 5 Second	• • •		300	°C

## **Thermal Characteristics**

Symbol	Parameter	FDPF041N06BL1	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	3.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max	62.5	*C/VV

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Packaging Type	Quantity
FDPF041N06BL1	FDPF041N06BL1	TO-220F	Tube	50

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	eteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	-	0.03	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$	-	-	1	μΑ
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	-	4	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 77A$	-	3.5	4.1	mΩ
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10V, I_{D} = 77A$	-	125	-	S

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V f = 1MHz	-	4280	5690	pF
C <sub>oss</sub>	Output Capacitance		-	1050	1400	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 11/11/2	-	23	-	pF
C <sub>oss(er)</sub>	Energy Related Output Capacitance	$V_{DS} = 30V, V_{GS} = 0V$	-	1787	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V		-	53	69	nC
$Q_{gs}$	Gate to Source Gate Charge	$V_{DS} = 30V, I_D = 100A$ $V_{GS} = 10V$	-	23	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		-	8	-	nC
V <sub>plateau</sub>	Gate Plateau Volatge	(Note 4	-	5.7	-	V
Q <sub>sync</sub>	Total Gate Charge Sync.	$V_{DS} = 0V$ , $I_D = 50A$ (Note 5	) -	48.6	-	nC
Q <sub>oss</sub>	Output Charge	$V_{DS} = 30V, V_{GS} = 0V$	-	63.8	-	nC

## **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		-	29	68	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 30V, I_{D} = 100A$	-	22	54	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 4.7\Omega$	-	38	86	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)	-	11	32	ns
ESR	Equivalent Series Resistance (G-S)	f = 1MHz	-	0.8	-	Ω

#### **Drain-Source Diode Characteristics**

Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	77	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	308	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 77A	-	-	1.25	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 100A	-	65	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	63	-	nC

#### Notes:

- Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 3mH,  $I_{AS}$  = 15.6A, Starting  $T_J$  = 25°C
- 3.  $I_{SD} \leq$  100A, di/dt  $\leq$  200A/ $\mu$ s,  $V_{DD} \leq$  BV $_{DSS}$ , Starting  $T_J$  = 25°C
- 4. Essentially Independent of Operating Temperature Typical Characteristics
- 5. See the test circuit in page 8

# **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

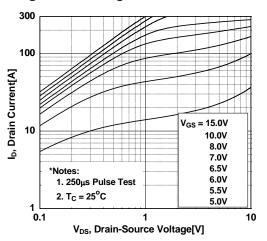


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

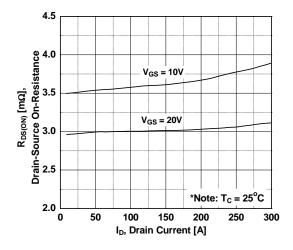


Figure 5. Capacitance Characteristics

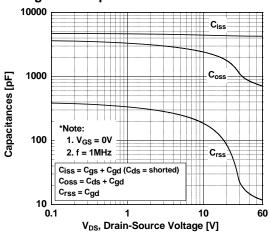


Figure 2. Transfer Characteristics

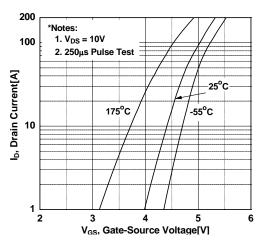
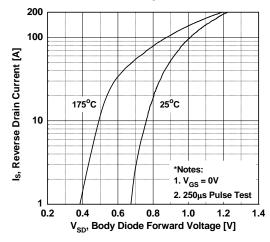
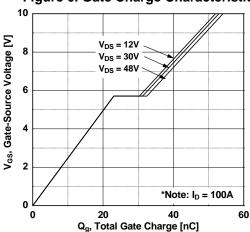


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



**Figure 6. Gate Charge Characteristics** 



# **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

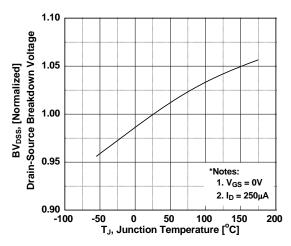


Figure 9. Maximum Safe Operating Area vs. Case Temperature

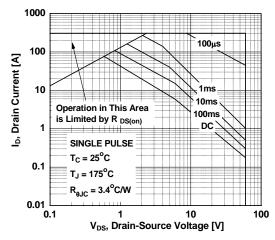


Figure 11. Eoss vs. Drain to Source Voltage

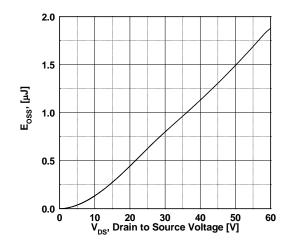


Figure 8. On-Resistance Variation vs. Temperature

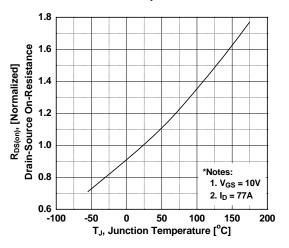


Figure 10. Maximum Drain Current

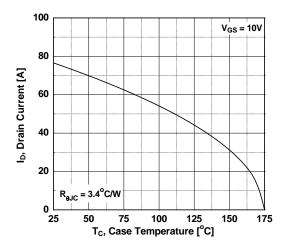
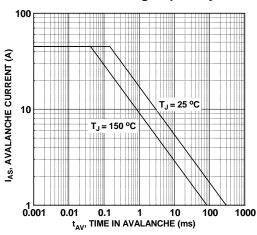
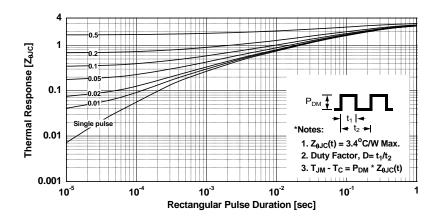


Figure 12. Unclamped Inductive Switching Capability

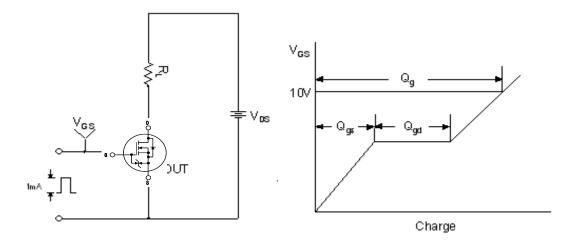


# **Typical Performance Characteristics** (Continued)

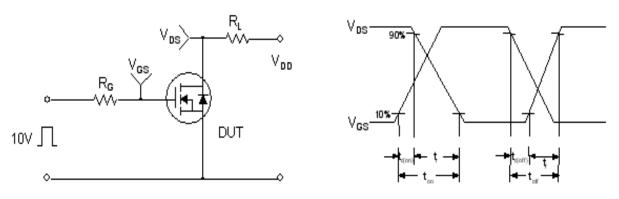




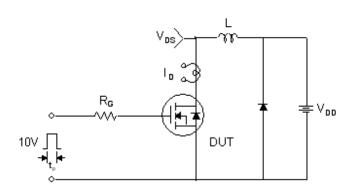
## **Gate Charge Test Circuit & Waveform**

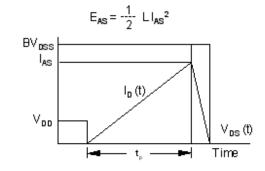


## **Resistive Switching Test Circuit & Waveforms**

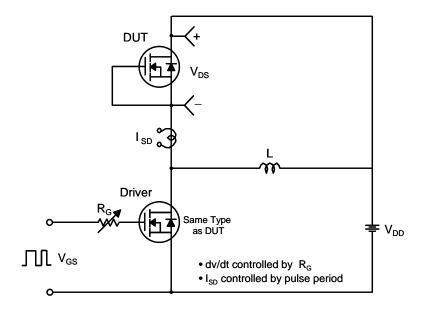


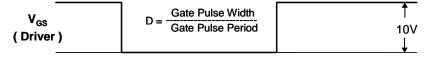
**Unclamped Inductive Switching Test Circuit & Waveforms** 

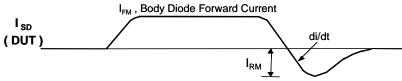




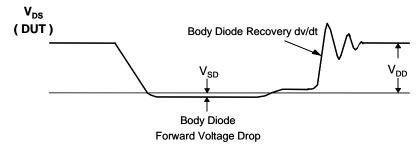
## Peak Diode Recovery dv/dt Test Circuit & Waveforms



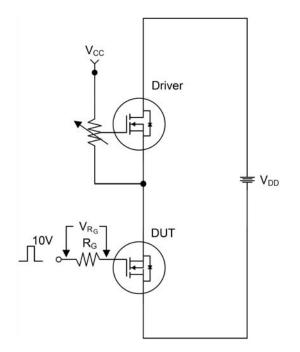


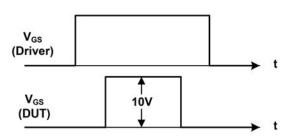


Body Diode Reverse Current

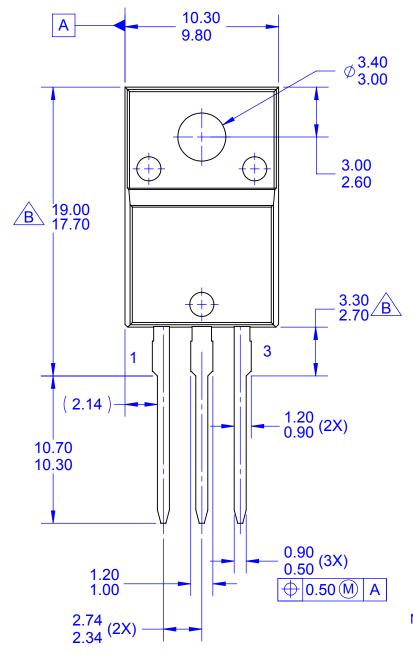


## Total Gate Charge Qsync. Test Circuit & Waveforms

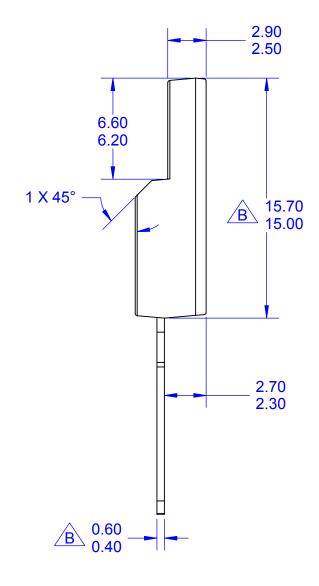




$$Qsync = \frac{1}{R_G} \cdot \int V_{R_G}(t) dt$$







## NOTES:

- A. EXCEPT WHERE NOTED CONFORMS TO
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